

Nozzle Temp	260°C-280°C
Bed Temp	110-130°C
Heated Enclosure	Recommended
Bed Adhesion	Hairspray, glue stick, or increase bed temperature
Drying Settings	60°C for 4 hours

Preferred Print Parameters

0.4mm Nozzle – 0.2mm Layer Height 260°C Extruder 120°C Bed 40mm/s

Printing Considerations

- Temperature variations: Larger nozzle diameters, higher volumetric flow, and faster print speeds will require higher nozzle temperatures.
- PC is a higher temp engineering material. It likes to shrink when it cools which can cause parts to warp up off of the print bed. Use build plate adhesive, higher temperatures, or a brim/raft to alleviate.
- Slower speeds and extra build plate adhesive may be needed for larger parts printed with PC.